TOSHIBA Diode Silicon Epitaxial Planar Type

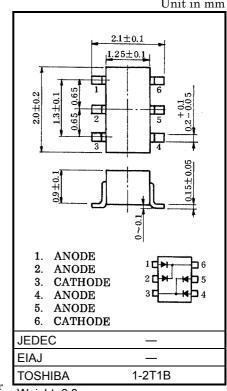
HN1D02FU

Ultra High Speed Switching Application

- HN1D02FU is composed of 2 unit of cathode common.
- $: V_{F(3)} = 0.90V (typ.)$ Low forward voltage
- Fast reverse recovery time: $t_{rr} = 1.6ns$ (typ.)
- Small total capacitance $: C_{T} = 0.9 pF (typ.)$

Maximum Ratings ($Ta = 25^{\circ}C$)

Characteristic	Symbol	Rating	Unit	
Maximum (peak) reverse voltage	V _{RM}	85	V	
Reverse voltage	V _R	80	V	
Maximum (peak) forward current	I _{FM}	300*	mA	
Average forward current	Ι _Ο	100*	mA	
Surge current (10ms)	I _{FSM}	2*	А	
Power dissipation	Р	200	mW	
Junction temperature	Тј	125	°C	
Storage temperature	T _{stg}	-55~125	°C	



This is the Maximum Ratings of single diode (Q1 or Q2 or Q3 or Q4). In the case of using Unit 1 and Unit 2 independently or simultaneously, the Maximum Ratings per diode is 75% of the single diode one.

Weight: 6.8mg

Electrical Characteristics (Q1, Q2, Q3, Q4 Common, Ta = 25°C)

Characteristic	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Forward voltage	V _{F (1)}	—	I _F = 1mA		0.60	_	v
	V _{F (2)}	—	I _F = 10mA		0.72	—	
	V _{F (3)}	—	I _F = 100mA	_	0.90	1.20	
Reverse current	I _{R (1)}	—	V _R = 30V	_	—	0.1	μA
	I _{R (2)}	—	V _R = 80V	_	_	0.5	
Total capacitance	CT	_	V _R = 0, f = 1MHz	_	0.9	3.0	pF
Reverse recovery time	t _{rr}	—	I _F = 10mA (fig.1)		1.6	4.0	ns

000707EAA1

TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property

In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc...

The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic applications (computer, personal neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document what he made at the customer or un rick. shall be made at the customer's own risk.

The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of TOSHIBA CORPORATION or others

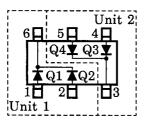
The information contained herein is subject to change without notice.

Unit in mm

TOSHIBA

0.1 I_R

Pin Assignment (Top View)



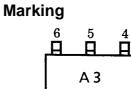
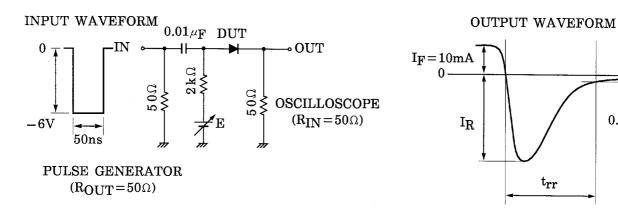


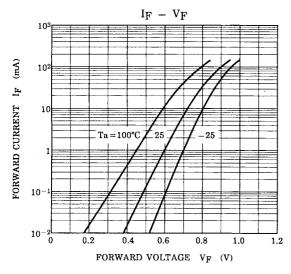


Fig.1 Reverse Recovery Time (trr) Test Circuit

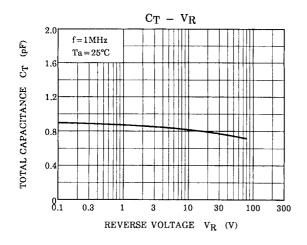


TOSHIBA

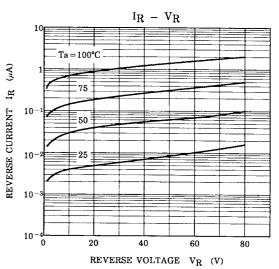
Q1. Q.2. Q3. Q4 Common



Q1, Q,2, Q3, Q4 Common



Q1. Q.2. Q3. Q4 Common



Q1, Q,2, Q3, Q4 Common

